

# **High Power, Drum Inductors**

## UNI-PAC™ UP2UC Series







#### Description

- Halogen Free, RoHS compliant
- 125°C maximum total temperature operation
- 9.5 x 12.7 x 5.21mm drum core
- · Ferrite core material
- Inductance range from 1.0μH to 1000μH
- Current range from 0.30 to 9.0 amps

## **Applications**

- Buck or boost inductor
- PDAs
- · Desktop computer
- DVD Players
- Portable power devices
- Output filter chokes
- Test equipment instrumentation

### **Environmental Data**

- Storage temperature range: -40°C to +125°C
- Operating temperature range: -40°C to +125°C (ambient plus self-temperature rise)
- Solder reflow temperature: J-STD-020D compliant

### **Packaging**

 Supplied in tape and reel packaging, 600 parts per reel, 13" diameter reel

Product Specifications							
	OCL1	I <sub>rms²</sub>	I <sub>sat³</sub>	SRF MHz	DCR mΩ@20°C	DCR mΩ@20°C	
Part Number⁵	μH ± 20%	Amps	Amps@25°C	Typical	Typical	Maximum	K-factor4
UP2UC-1R0-R	1.0	6.8	9.0	100	4.0	9.0	216
UP2UC-1R5-R	1.5	6.4	8.0	90.0	4.4	10.0	177
UP2UC-2R2-R	2.2	6.1	7.0	80.0	5.8	12.0	130
UP2UC-3R3-R	3.3	5.4	6.4	65.0	9.9	15.0	114
UP2UC-4R7-R	4.7	4.8	5.4	45.0	12.0	18.0	92.52
UP2UC-6R8-R	6.8	4.4	4.6	38.0	25.8	27.0	77.72
UP2UC-100-R	10.0	3.9	3.8	30.0	25.9	38.0	62.68
UP2UC-150-R	15.0	3.1	3.0	27.0	35.4	46.0	49.82
UP2UC-220-R	22.0	2.7	2.6	19.0	55.9	85.0	41.34
UP2UC-330-R	33.0	2.1	2.0	15.0	81.6	100	34.09
UP2UC-470-R	47.0	1.8	1.6	12.0	120	140	29.00
UP2UC-680-R	68.0	1.5	1.4	10.0	145	200	24.59
UP2UC-101-R	100	1.3	1.2	9.0	211	280	20.89
UP2UC-151-R	150	1.0	1.0	6.0	347	400	15.80
UP2UC-221-R	220	0.80	0.80	5.0	491	610	13.04
UP2UC-331-R	330	0.60	0.60	4.5	750	1020	10.85
UP2UC-471-R	470	0.50	0.50	3.5	1188	1270	9.39
UP2UC-681-R	680	0.40	0.40	2.5	1811	2020	7.56
UP2UC-102-R	1000	0.30	0.30	2.0	2757	3000	6.13

- 1 Open Circuit Inductance (OCL) Test Parameters: 100kHz, 0.25V<sub>rms</sub>, 0.0Adc
- 2 I<sub>rms</sub>: DC current for an approximate ΔT rise of 40°C without core loss. Derating is necessary for AC currents. PCB layout, trace thickness and width, air-flow and proximity of other heat generating components will affect the temperature rise. It is recommended the part temperature not exceed 125°C under worst case operating conditions verified in the end application.
- 3 I<sub>sat</sub>: Peak current for approximately 7.5% rolloff at 25°C.

- 4 K-factor: Used to determine B $_{p-p}$  for core loss (see graph). B $_{p-p} = \text{K} \star \text{L} \star \Delta \text{I}_{,} \text{B}_{p-p}$ : (Gauss),
- K: (K-factor from table), L: (inductance in  $\mu$ H),  $\Delta$ I (peak-to-peak ripple current in amps).
- 6 Part Number Definition: UP2CU-xxx-R
  - UP2CU = Product code and size
  - ullet xxx= Inductance value in  $\mu$ H, R = decimal point. If no R is present, then third digit equals the number of zeros.

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• "-R" suffix = RoHS compliant

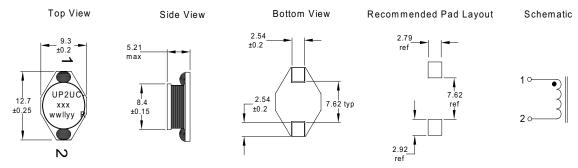
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## Dimensions - mm

Tolerances are  $\pm 0.254$ mm unless otherwise specified.



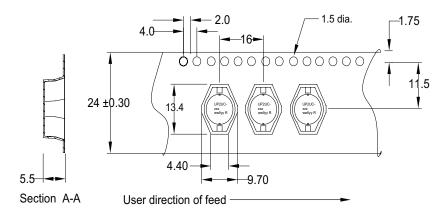
Part Marking: UP2UC

xxx =Inductance value in  $\mu$ H (R = Decimal point). If no "R" is present, then the third digit equals the number of zeros.

wwllyy = Date code

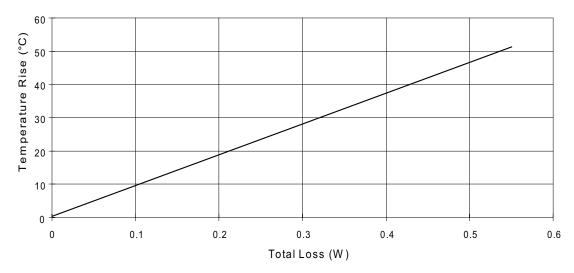
R = Revision level

## Packaging Information - mm



Supplied in tape-and-reel packaging, 600 parts per reel, 13" diameter reel.

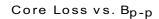
## Temperature Rise vs. Total Loss

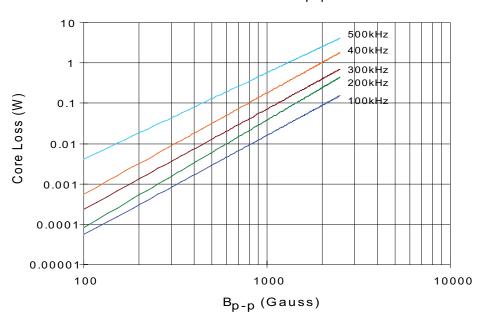


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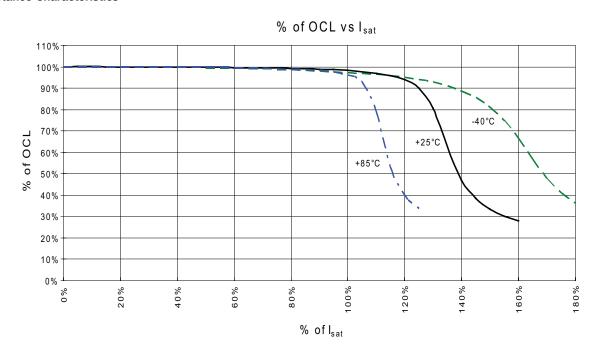


## **Core Loss**





## inductance Characteristics



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#### Solder Reflow Profile

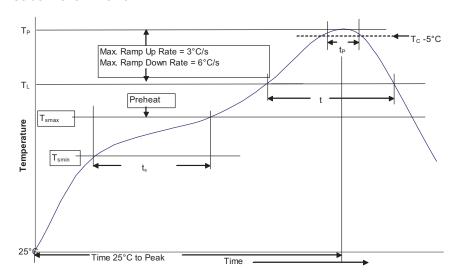


Table 1 - Standard SnPb Solder (T<sub>C</sub>)

Package	Volume mm³	Volume mm³
Thickness	<350	≥350
<2.5mm	235°C	220°C
≥2.5mm	220°C	220°C

Table 2 - Lead (Pb) Free Solder (Tc)

Package Thickness	Volume mm³ <350	Volume mm <sup>3</sup> 350 - 2000	Volume mm³ >2000
<1.6mm	260°C	260°C	260°C
1.6 - 2.5mm	260°C	250°C	245°C
>2.5mm	250°C	245°C	245°C

## **Reference JDEC J-STD-020D**

Profile Feature		Standard SnPb Solder	Lead (Pb) Free Solder	
Preheat and Soak	• Temperature min. (T <sub>smin</sub> )	100°C	150°C	
	<ul> <li>Temperature max. (T<sub>smax</sub>)</li> </ul>	150°C	200°C	
	• Time (T <sub>smin</sub> to T <sub>smax</sub> ) (t <sub>s</sub> )	60-120 Seconds	60-120 Seconds	
Average ramp up rate T <sub>Smax</sub> to T <sub>p</sub>		3°C/ Second Max.	3°C/ Second Max.	
Liquidous temperature (TL) Time at liquidous (t <sub>I</sub> )		183°C 60-150 Seconds	217°C 60-150 Seconds	
Peak package body temperature (Tp)*		Table 1	Table 2	
Time $(t_p)^{**}$ within 5 °C of the specified classification temperature $(T_c)$		20 Seconds**	30 Seconds**	
Average ramp-down rate (T <sub>p</sub> to T <sub>smax</sub> )		6°C/ Second Max.	6°C/ Second Max.	
Time 25°C to Peak Temperature		6 Minutes Max.	8 Minutes Max.	

<sup>\*</sup> Tolerance for peak profile temperature (Tp) is defined as a supplier minimum and a user maximum.

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<sup>\*\*</sup> Tolerance for time at peak profile temperature  $(t_p)$  is defined as a supplier minimum and a user maximum.